

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Ashish Asthana	09/15/2009
Farooq Quadri	09/15/2009
RECEIVING PARTY DATA	
Name:	Ananda Kumar
Street Address:	1999 Blackfoot Drive
City:	Fremont
State/Country:	CALIFORNIA
Postal Code:	94539
PROPERTY NUMBERS Total: 4	
Property Type	Number
Application Number:	61096315
Application Number:	12558486
Application Number:	12558490
PCT Number:	US0956761
CORRESPONDENCE DATA	
Fax Number:	(510)656-4420
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	(510) 299-7249
Email:	nguyentue@yahoo.com
Correspondent Name:	Tue Nguyen
Address Line 1:	496 Olive Ave.
Address Line 4:	Fremont, CALIFORNIA 94539
NAME OF SUBMITTER:	Tue Nguyen
Total Attachments: 8 source=andy001_2009-09-11_assignment-prov#page1.tif	

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PATENT
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source=pct-ahk001_2009-09-11_assignment-w-number#page1.tif
source=pct-ahk001_2009-09-11_assignment-w-number#page2.tif

ASSIGNMENT

Whereas, the undersigned Inventor, Farooq Quadri, a resident of San Ramon, California, has invented a certain new and useful improvement in:

Structures and Methods for Wafer Packages, and Probes

and has executed a declaration or oath for an application for a United States provisional patent disclosing and identifying the invention, the invention has been filed on September 12, 2008, with docket number ANDY001 and application serial number 61/096,315.

Whereas, Ananda H. Kumar, hereafter referred to as "assignee", whose mailing address is 1999 Blackfoot Dr. Fremont, CA 94539, wishes to acquire the entire right, title and interest in the same.

Now, therefore, for good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee, said Inventor does hereby sell, assign, and transfer unto said Assignee the entire right, title and interest

(a) in and to said invention and said application, including any provisional application for which said application claims benefit;

(b) in and to all rights to apply in any or all countries in the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patent pursuant to the International Convention for the Protection of Industrial Property or pursuant to other convention, treaty, agreement, or understanding;

(c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications, including any provisional application for which said applications claim benefit;

(d) in and to each and every reissue or extension of any of said patents; and

(e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, his or her respective heirs, legal representatives and assigns.

IN WITNESS WHEREOF, said Inventor has executed this instrument on the date as given below and delivered this instrument to said Assignee:

9/5/2009
Date


Farooq Quadri

ASSIGNMENT

Whereas, the undersigned Inventor, Ashish Asthana, a resident of Fremont, California, has invented a certain new and useful improvement in:

Structures and Methods for Wafer Packages, and Probes

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IN WITNESS WHEREOF, said Inventor has executed this instrument on the date as given below and delivered this instrument to said Assignee:

9/4/2009

Date



Ashish Asthana

ASSIGNMENT

Whereas, the undersigned Inventor, Farooq Quadri, a resident of San Ramon, California, has invented a certain new and useful improvement in:

Structures and Methods for Wafer and Device Packages and Probes

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(d) in and to each and every reissue or extension of any of said patents; and

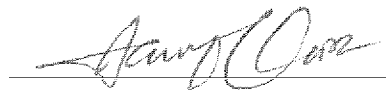
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Farooq Quadri

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9/4/2009

Date



Farooq Quadri

Application Serial No. PCT/US2009/56761, filed 9/12/2009

ASSIGNMENT

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Ashish Asthana

Application Serial No. PCT/US2009/56761, filed 9/12/2009